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<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> ( Not for submission under 37 CFR 1.99)	Application Number		10519337	
	Filing Date		2004-12-22	
	First Named Inventor	Nancy Dean		
	Art Unit	1794		
	Examiner Name	Kevin R. Kruer		
	Attorney Docket Number	H0004275.68586 US - 4018		

U.S.PATENTS						
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Examiner Initial*	Cite No	Publication Number	Kind Code <sup>1</sup>	Publication Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear
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